

## Features

- Ideally Suited for Automatic Insertion
- Epitaxial Planar Die Construction
- Complementary NPN Types Available (BC817-xxW)
- For Switching and AF Amplifier Applications
- **Totally Lead-Free & Fully RoHS Compliant (Note 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

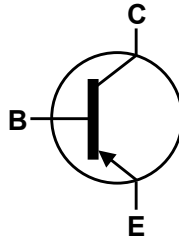
## Mechanical Data

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound  
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 <sup>(e3)</sup>
- Weight 0.006 grams (approximate)

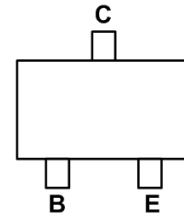
SOT323



Top View



Device Symbol



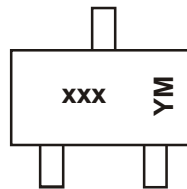
Top View  
Pin-Out

## Ordering Information (Notes 4)

Product	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
BC807-16W-7	K5A	7	8	3,000
BC807-25W-7	K5B	7	8	3,000
BC807-40W-7	K5C	7	8	3,000

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

## Marking Information



xxx = Product Type Marking Code  
(Please see Ordering Information)  
YM = Date Code Marking  
Y or  $\bar{Y}$  = Year (ex: A = 2013)  
M or  $\bar{M}$  = Month (ex: 9 = September)

### Date Code Key

Year	2010	2011	2012	2013	2014	2015	2016	2017
Code	X	Y	Z	A	B	C	D	E

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

**Absolute Maximum Ratings** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	$V_{CBO}$	-50	V
Collector-Emitter Voltage	$V_{CEO}$	-45	V
Emitter-Base Voltage	$V_{EBO}$	-6	V
Continuous Collector Current	$I_C$	-500	mA
Peak Collector Current	$I_{CM}$	-1.0	A
Peak Base Current	$I_{BM}$	-200	mA

**Thermal Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	$P_D$	200	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	625	$^\circ\text{C}/\text{W}$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-65 to +150	$^\circ\text{C}$

**ESD Ratings** (Note 6)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	C

**Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition	
Collector-Emitter Breakdown Voltage (Note 7)	$BV_{CEO}$	-45	—	—	V	$I_C = -10\text{mA}$	
Emitter-Base Breakdown Voltage	$BV_{EBO}$	-6	—	—	V	$I_C = -100\mu\text{A}$	
Collector-Emitter Cutoff Current	$I_{CES}$	—	—	-100 -5.0	nA $\mu\text{A}$	$V_{CE} = -45\text{V}$ $V_{CE} = -25\text{V}, T_J = +150^\circ\text{C}$	
Collector	$I_{CBO}$	—	—	-100 -5.0	nA $\mu\text{A}$	$V_{CB} = -20\text{V}$ $V_{CB} = -20\text{V}, T_J = +150^\circ\text{C}$	
Emitter-Base Cutoff Current	$I_{EBO}$	—	—	-100	nA	$V_{EB} = -5\text{V}$	
DC Current Gain (Note 7)	$h_{FE}$	BC807-16W-7 BC807-25W-7 BC807-40W-7	100 160 250	—	250 400 600	—	$I_C = -100\text{mA}, V_{CE} = -1.0\text{V}$
		BC807-16W-7 BC807-25W-7 BC807-40W-7	60 100 170	—	—	—	$I_C = -300\text{mA}, V_{CE} = -1.0\text{V}$
Collector-Emitter Saturation Voltage (Note 7)	$V_{CE(sat)}$	—	—	-700	mV	$I_C = -500\text{mA}, I_B = -50\text{mA}$	
Base-Emitter Voltage (Note 7)	$V_{BE}$	—	—	-1200	mV	$I_C = -300\text{mA}, V_{CE} = -1.0\text{V}$	
Gain Bandwidth Product	$f_T$	100	—	—	MHz	$V_{CE} = -5.0\text{V}, I_C = -10\text{mA}, f = 50\text{MHz}$	
Collector-Base Capacitance	$C_{CBO}$	—	—	12	pF	$V_{CB} = -10\text{V}, f = 1.0\text{MHz}$	

- Notes:
- For a device mounted on minimum recommended pad layout 1oz copper that is on a single-sided FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.
  - Refer to JEDEC specification JESD22-A114 and JESD22-A115.
  - Measured under pulsed conditions. Pulse width  $\leq 300\mu\text{s}$ . Duty cycle  $\leq 2\%$ .

**Typical Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

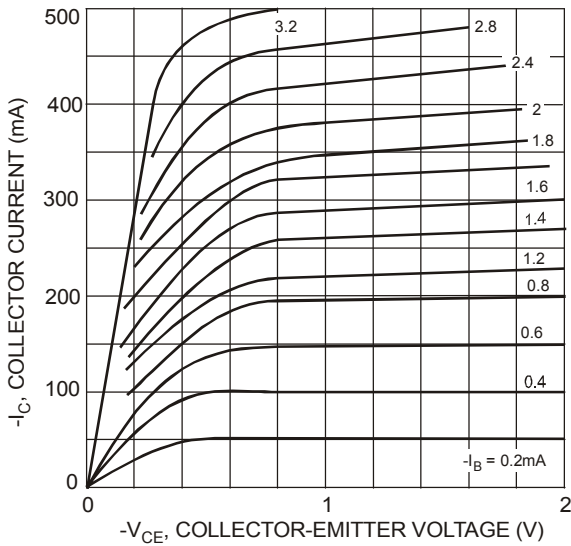


Figure 1 Typical Collector Current vs. Collector-Emitter Voltage

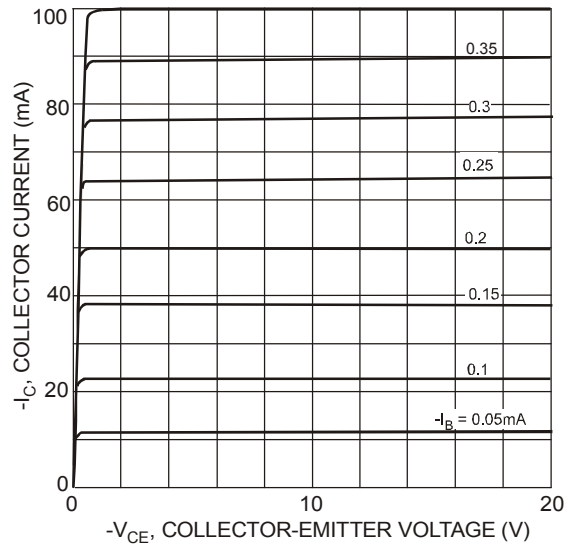


Figure 2 Typical Collector Current vs. Collector-Emitter Voltage

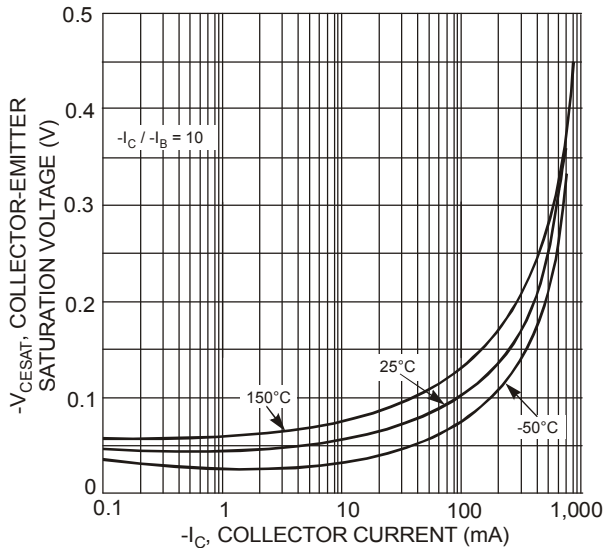


Figure 3 Typical Collector-Emitter Saturation Voltage vs. Collector Current

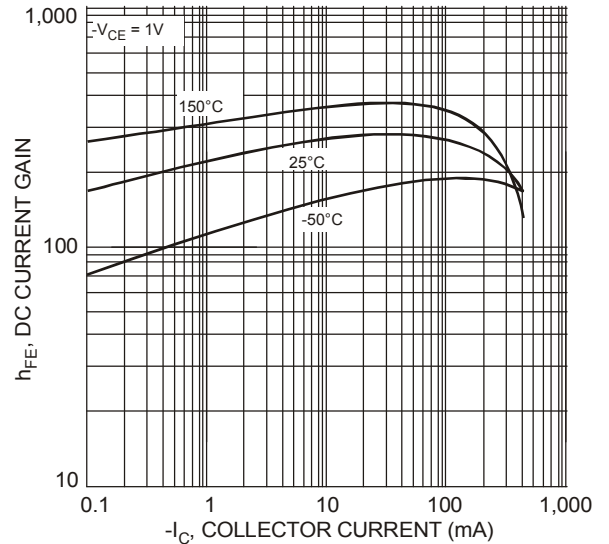


Figure 4 Typical DC Current Gain vs. Collector Current

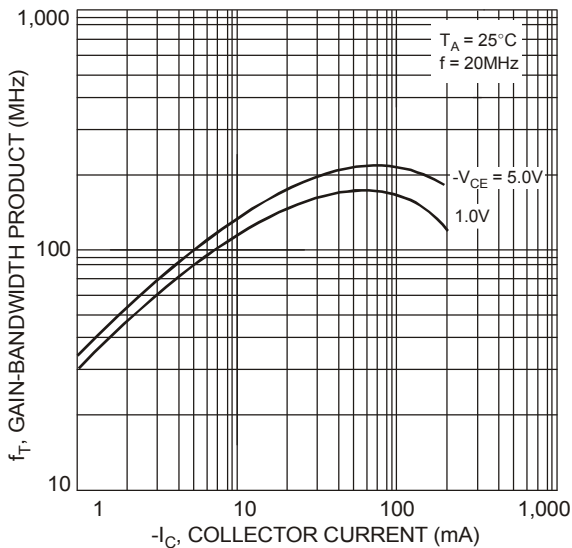
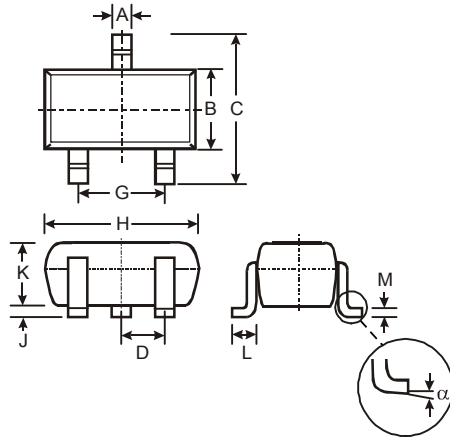


Figure 5 Typical Gain-Bandwidth Product vs. Collector Current

## Package Outline Dimensions

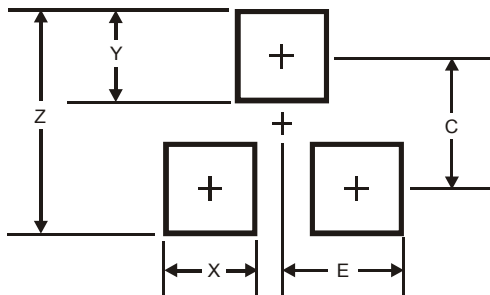
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



SOT323			
Dim	Min	Max	Typ
A	0.25	0.40	0.30
B	1.15	1.35	1.30
C	2.00	2.20	2.10
D	-	-	0.65
G	1.20	1.40	1.30
H	1.80	2.20	2.15
J	0.0	0.10	0.05
K	0.90	1.00	1.00
L	0.25	0.40	0.30
M	0.10	0.18	0.11
$\alpha$	0°	8°	-
All Dimensions in mm			

## Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
Z	2.8
X	0.7
Y	0.9
C	1.9
E	1.0

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